

# Standard Power MOSFET

IXTH 8P50 IXTT 8P50

P-Channel Enhancement Mode Avalanche Rated

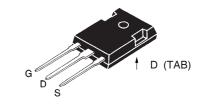


Symbol	<b>Test Conditions</b>	<b>Maximum Ratings</b>		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	-500	V	
V <sub>DGR</sub>	$T_J = 25^{\circ}C$ to 150°C; $R_{GS} = 1 M\Omega$	-500	V	
V <sub>GS</sub>	Continuous	±20	V	
V <sub>GSM</sub>	Transient	±30	V	
I <sub>D25</sub>	T <sub>c</sub> = 25°C	-8	A	
I <sub>DM</sub>	$T_{c} = 25^{\circ}C$ , pulse width limited by $T_{J}$	-32	Α	
I <sub>AR</sub>	$T_{c} = 25^{\circ}C$	-8	Α	
<b>E</b> <sub>AR</sub>	T <sub>C</sub> = 25°C	30	mJ	
$\overline{P_{D}}$	T <sub>C</sub> = 25°C	180	W	
$T_{J}$		-55 +150	°C	
T <sub>JM</sub>		150	°C	
T <sub>stg</sub>		-55 +150	°C	
	Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s	300	°C	
	Plastic Body for 10s	250	°C	
M <sub>d</sub>	Mounting torque (TO-247)	1.13/10	Nm/lb.in.	
Weight	TO-247	6	g	
	TO-268	5	g	

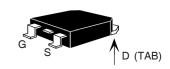
Symbol	Test Conditions	(T <sub>J</sub> = 25°C,	unless			
V <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$ BV <sub>DSS</sub> Temperature Coefficients	ent	-500	0.054		V %/K
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$ $V_{GS(th)}$ Temperature Coefficien	nt	-3.0	-0.122	-5.0	V %/K
I <sub>GSS</sub>	$V_{GS} = \pm 20 \ V_{DC}, \ V_{DS} = 0$				±100	nA
DSS	$V_{DS} = 0.8 \cdot V_{DSS}$ $V_{GS} = 0 V$	$T_J = 25$ °C $T_J = 125$ °C			-200 -1	μA mA
R <sub>DS(on)</sub>	$V_{gs} = -10 \text{ V}, I_{D} = 0.5 \cdot I_{D25}$	7P50 8P50			1.5 1.2	Ω
	$R_{DS(on)}$ Temperature Coefficie	nt			0.6	%/K

 $V_{DSS} = -500 V$   $I_{D25} = -8 A$   $R_{DS(on)} = 1.2 \Omega$ 

TO-247 (IXTH)



TO-268 (IXTT)



G = Gate, D = Drain, S = Source, TAB = Drain

#### **Features**

- International standard packages
- $^{\bullet} \ \mathsf{Low} \ \mathsf{R}_{\mathsf{DS} \ \mathsf{(on)}} \ \mathsf{HDMOS^{\mathsf{TM}}} \ \mathsf{process}$
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance (<5 nH)
  - easy to drive and to protect

### **Applications**

- High side switching
- Push-pull amplifiers
- DC choppers
- Automatic test equipment

## Advantages

- Easy to mount with 1 screw (isolated mounting screw hole)
- Space savings
- High power density

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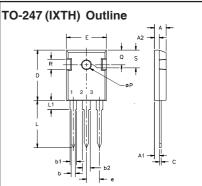
Symbol		Characteristic Values T <sub>.1</sub> = 25°C, unless otherwise specified)			
	min.	typ.	max.		
g <sub>fs</sub>	$V_{DS} = -10 \text{ V}; I_{D} = I_{D25}, \text{ pulse test}$ 4	5	S		
C <sub>iss</sub>	)	3400	pF		
C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	450	pF		
$\mathbf{C}_{rss}$	J	175	pF		
t <sub>d(on)</sub>	)	33	ns		
t <sub>r</sub>	$V_{gs} = -10 \text{ V}, V_{DS} = 0.5 V_{DSS} I_{D} = 0.5 I_{D25}$	27	ns		
$\mathbf{t}_{d(off)}$	$R_{\rm G} = 4.7 \Omega $ (External)	35	ns		
t <sub>f</sub>	J	35	ns		
$\overline{\mathbf{Q}_{g(on)}}$	)	130	nC		
$\mathbf{Q}_{gs}$	$V_{GS} = -10 \text{ V}, V_{DS} = 0.5 V_{DSS} I_{D} = 0.5 I_{D25}$	32	nC		
$\mathbf{Q}_{gd}$	J	64	nC		
R <sub>thJC</sub>			0.7 K/W		
R <sub>thCS</sub>	(TO-247)	0.25	K/W		

#### Source-Drain Diode

## **Characteristic Values**

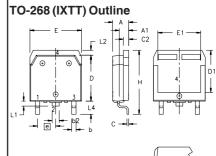
 $(T_J = 25^{\circ}C, \text{ unless otherwise specified})$ 

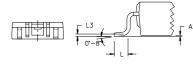
Symbol	Test Conditions	min.	typ.	max.	
I <sub>s</sub>	V <sub>GS</sub> = 0			-8	Α
I <sub>sm</sub>	Repetitive; pulse width limited by T <sub>JM</sub>			-32	Α
V <sub>SD</sub>	$\begin{split} &I_{_F} = I_{_S},  V_{_{GS}} = 0  V, \\ &\text{Pulse test, t} \leq 300  \mu\text{s, duty cycle d} \leq 2  \% \end{split}$			-3	V
t <sub>rr</sub>	$I_F = I_S$ , di/dt = 100 A/ $\mu$ s		400		ns



Terminals: 1 - Gate 2 - Drain 3 - Source Tab - Drain

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
Α	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A 2	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
С	.4	.8	.016	.031
D	20.80	21.46	.819	.845
Е	15.75	16.26	.610	.640
е	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
ØP	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC





MY2	INCHES		MILLIMETERS	
2 I M	MIN	MAX	MIN	MAX
Α	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
С	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
Ε	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
е	.215 BSC		5.45 BSC	
Н	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010	BSC	0.25 BSC	
L4	.150	.161	3.80	4.10

IXYS reserves the right to change limits, test conditions, and dimensions.

